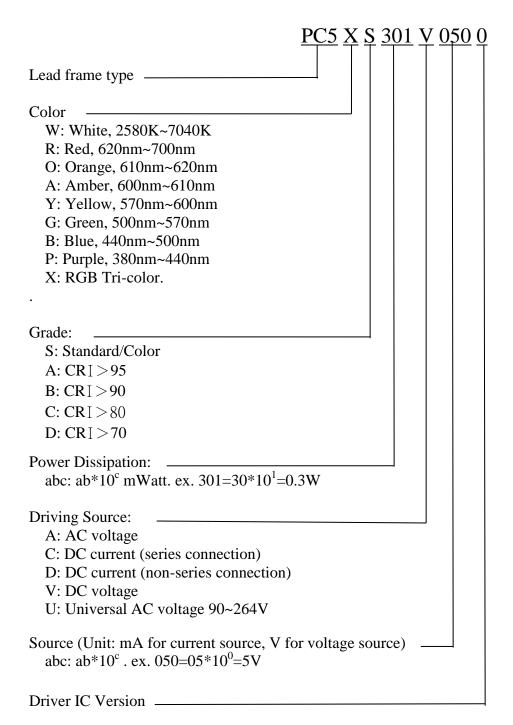


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1. MODEL:



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2.FEARTURES

- Functional led , Self-addressed , single point control.
- Small package with integrated RGB leds and drive IC.
- Easy control by MCU.
- Simplifying circuit design and PCB layout for designer.
- Diffused encapsulant to make excellent distribution for luminous intensity and radiation. (patent pending)
- Wide viewing angle. (120°)
- Compatible with IC SM16726, SM16716

3.APPLICATIONS

- Automotive: indoor/outdoor lighting
- Channel Letter
- Decorative Lighting
- Glass panel
- LED Display

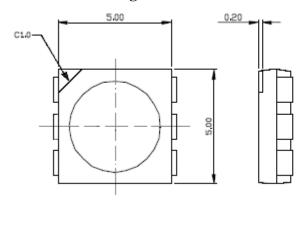


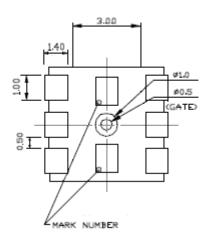
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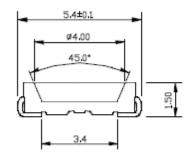
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4. OUTLINE DRAWING:

4.1 Outline Drawing



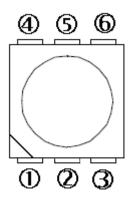




Note:

- 1. Unit: mm
- 2. Tolerance: Dimension \pm 0.1 / Angle \pm 0.5°

4.2 Pin Assignment



Pin No.	Function	Function description
0	Clock Out	Clock output
2	Data Out	Data output
3	Data In	Data input
4	GND	Ground
⑤	V _{CC}	Power input of LED
6	Clock In	Clock input

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5. ABSOLUTE MAXIMUM RATINGS (TA=25°C)

Parameter	Symbol	Range	Unit
Forward Voltage	V_{DD}	3.5~5.5	V
Logic Voltage Input	$V_{\mathrm{IN_D}}$	-0.5~5.5	V
Power Dissipation	P_D	550	mW
Forward Current	I _F (R/B/G)	20/20/20	mA
Frequency of clock	F_{CLK}	30	MHZ
Operating Temperature	T_{OPT}	-40~85	°C
Storge Temperature	$T_{ m STG}$	-40~100	°C

6. ELECTRICAL STATIC CHARACTERISTICS

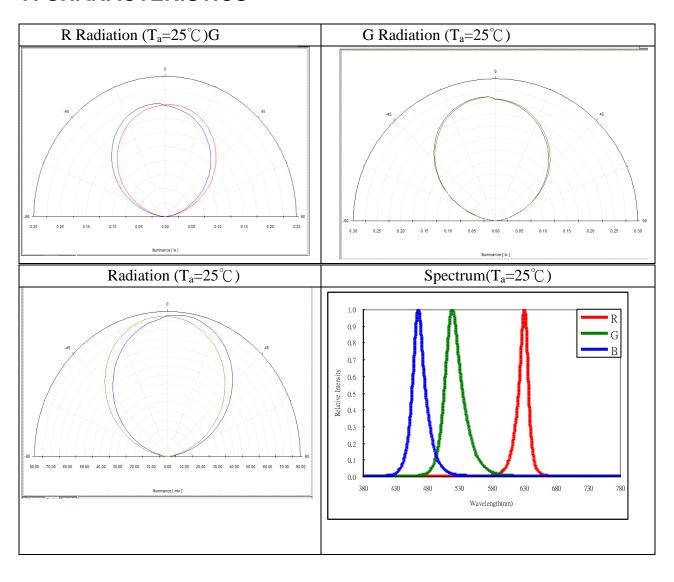
Parameter		Symbol	Test Condition	Min.	Тур.	Max.	Unit
Forward Voltage		V_{DD}		4	5	7	V
High Level Input Volta	.ge	V_{IH}	$V_{\rm DD} = 5$	2.9	3.1	3.3	V
Low Level Input Volta	ge	V _{IL}	$V_{\rm DD} = 5$	1.4	1.6	1.8	V
	R			620		625	
LED Wavelength $V_{DD} = V_{CC} = 5V$	G	$\lambda_{ m d}$		523		528	nm
Y DD Y CC O Y	В			465		470	
	R			600		750	
Luminous Intensity $V_{DD} = V_{CC} = 5V$	G	Iv		1200		1450	mcd
DD YCC OY	В			350		500	

^{*} V_{DD} : IC Operation Voltage

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7. CHARACTERISTICS



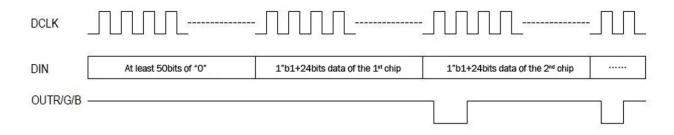
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8. PROTOCOL AND APPLICATION NOTES

8.1.A Protocol

Data transmission method



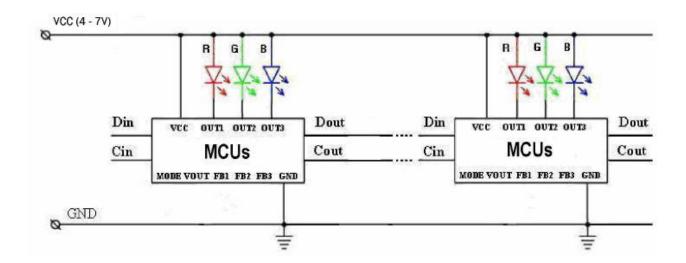
- 1. The first 50bits of "0" is the start frame data, followed by data frame. At the rising edge of Cin, the high bit of start frame and data frame are sent first, DCLK rising to save data.
- 2. The MCU next to the controller receives the first data frame, the frame contains one start bit and 24-bit gray level data for RGB.

1"bit + 24bit data structure

1	В7	В6	В5	B4	В3	B2	В1	ВО	R7	R6	R5	R4	R3	R2	R1	R0	G7	G6	G5	G4	G3	G2	G1	G0
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^{*}Send the high bit at first, then send the data according to the BRG sequence.

8.1.B Typical Applications



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8.2 Application Notes

Example: One BRG unit

Color Pattern: 1BBB BBBB BRRR RRRR RGGG GGGG G

MSB will be transmitted first.

Case I: 100% Blue for 1st LED, 100% Red for 2nd LED, 100% Green for 3rd LED:

 $0000\ 0000$

Case II: 12/24 Blue for 1st LED, 12/24 Red for 2nd LED, 12/24 Green for 3rd LED:

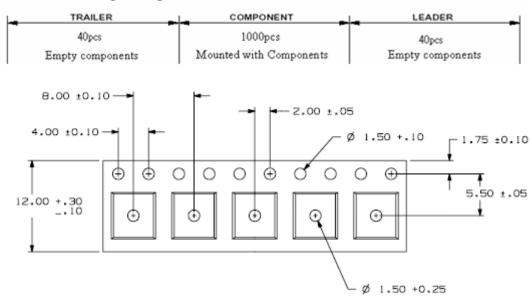
 $0000\ 0000$

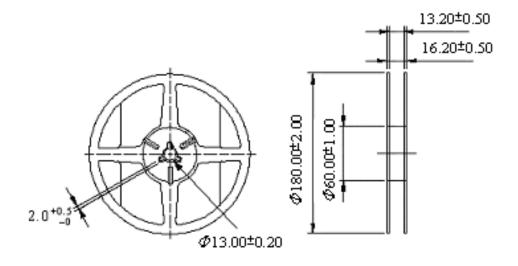
Case III: 100% White for 1st LED, 12/24 Blue+12/24Green for 2nd LED, 12/24 Blue for 3rd LED:

 $0000\ 0000$

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9. REEL PACKAGE:





Note:

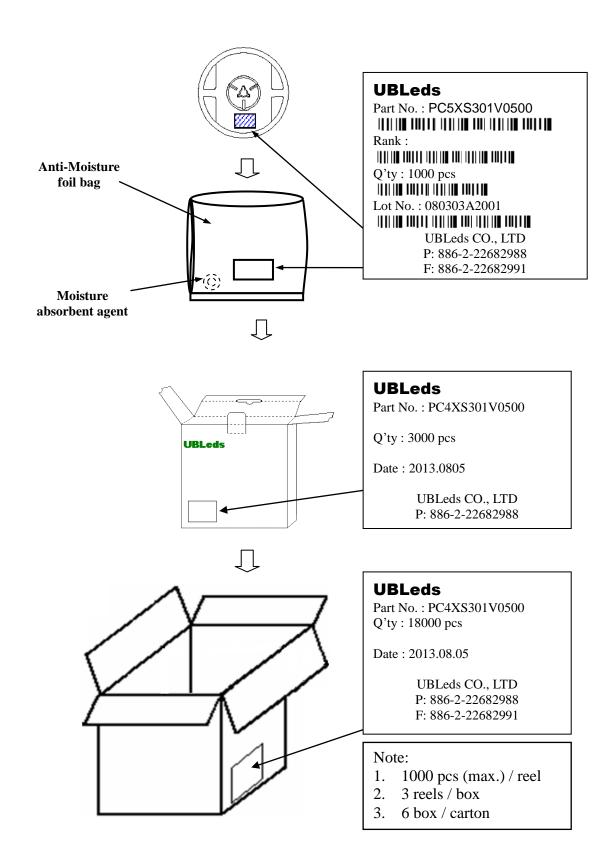
1. Unit: mm

2. 1,000 pcs / reel

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10. SHIPPING PACKAGE:



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11. RELIABILITY PLAN:

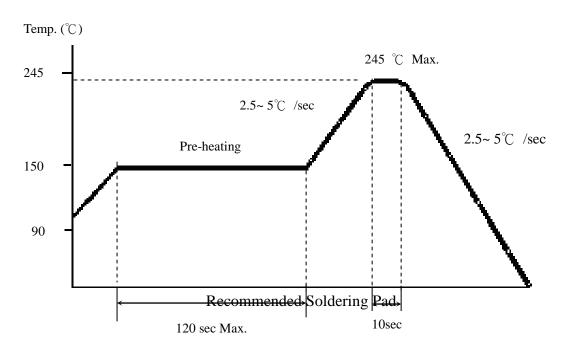
* The reliability of products shall be satisfied with items listed below.

Confidence Level: 95 %

No	Test Item	Description & Condition		Sample size	Ac/Re
1	Solderability	Tsld = $245\pm5^{\circ}$ C, 10 sec,	2 time	22	0/1
2	Low Temperature Storage	Ta = -40 °C	1000 hrs	22	0/1
3	High Temperature Storage	Ta = 100 °C	1000 hrs	22	0/1
4	High Temperature Running Test	Ta = 100 °C	1000 hrs	22	0/1
5	Temperature Cycling	-40°C ~ 100°C	300 cycles	22	0/1

12. SOLDERING CONDITIONS:

(1) Recommended Re-flow profile



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- (2) Re-flow soldering should not be done more than two times.
- (3) It is recommended that the user use the nitrogen reflow method.
- (4) When soldering, don't put stress on the LEDs during heating.
- (5) After soldering, don't warp the circuit board.
- (6) It is recommended that isopropyl alcohol (IPA) be used as a solvent for cleaning the LEDs.

13.CAUTIONS:

(1)Storage

• Before opening the package :

The LEDs should be kept at 30°C or less and 30%RH~85%RH. The LEDs should be used within a year. When storing the LEDs, moisture proof packaging with desiccant (Silica gel)is recommended.

• After opening the package :

The LEDs should be kept at 30°C or less and 30%RH~70%RH. The LEDs should be soldered within 168hours (7days) after opening the package. If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with packages of moisture desiccant (Silica ge1), or reseal the moisture proof bag again.

If the moisture desiccant (Silica ge1)has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment: 24 hours at 60°C on tap and reel, 7 hours at 125°C have no reel&tap.

Please avoid conditions which may cause the LED to corrode, tarnish or discolor. This corrosion or discoloration might lower solderability or might effect on optical characteristics.-Please avoid rapid transitions in ambient temperature, especially in high humidity environments where condensation can occur.

• Moisture Proof package

When moisture is absorbed into the SMT package it may vaporize and expand during soldering. There is a possibility that this can cause exfoliation of the contacts and damage to the optical characteristics of the LEDs. For this reason, the moisture proof package is used to keep moisture to a minimum in the package. A package of a moisture desiccant (silica gel)is inserted into the moisture proof bag-The silica gel changes its color from blue to pink as it absorbs moisture.

(2)Static Electricity

- Static electricity or surge voltage damages the LEDs. It is recommended that a wrist band or an anti-electrostatic glove and shoe be used when handling the LEDs.
- All devices, equipment and machinery must be properly grounded. It is recommended that measures be taken against surge voltage to the equipment that mounts the LEDs.
- when inspecting the final products in which LEDs were assembled, it is recommended to check whether the assembled LEDs are damaged by static electricity or not. It is easy to End static-damaged LEDs by a light-on test or a V_F test at a lower current (below l mA).
- Damaged LEDs will show some unusual characteristics such as the leak current remarkably increases, the forward voltage becomes lower, or the LEDs do not light at the low current. (Criteria: $V_F > 2.0V$ at $I_F = 0.5 \text{mA}$.)

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(3)Heat Generation

- Please consider the heat generation of the LED when making the system design that it's very importance. The coefficient of temperature increase per input electric power is effected by the thermal resistance of the circuit board and density of LED placement on the board, and other components. It is necessary to avoid intense heat generation and operate within the maximum ratings given in this specification.
- The operating current should be decided after considering the ambient maximum temperature of LEDs.

(4)Others

- Care must be taken to ensure that the reverse voltage will not exceed the absolute maximum rating when using the LEDs with matrix drive.
- The LED light output is strong enough to injure human eyes. Precautions must be taken to prevent looking directly for more than a few seconds. Flashing lights have been known to cause discomfort in people; you can prevent this by taking precautions during use. Also, people should be cautious when using equipment that has had LEDs incorporated into it.

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